

FORM **PTO-1595** (Rev. 6-93) OMD No. 0651-0011 (exp. 4/94) Rε

100905734 **PATENTS ONLY**

.S. DEPARTMENT OF COMMERC

Patent and Trademark Office

ONID NO. 0031-0011 (exp. 4/94)			
To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.			
1. Name of conveying party(ies): WEN-KUAN YEH; JIH-WEN CHOU	2. Name and address of receiving party(ies): Name: UNITED MICROELECTRONICS CORP.		
	Internal Address:		
Additional name(s) of conveying party(ies) attached?			
3. Nature of Conveyance: ⊠ Assignment	No. 3, Li-Hsin Rd. II, Street Address: Science-Based Industrial Park		
☐ Security Agreement ☐ Change of Name			
Other	City: Hsinchu State: Taiwan, R.O.C. ZIP:		
Execution Date:	Additional name(s)& address(es) attached? 🗵 No 🗌 Yes		
4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: 10/07/ A. Patent Application No.(s) B. Patent No.(s)			
09/19/202 Additional numbers attached?			
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:		
Name: Blakely, Sokoloff, Taylor & Zafman	7. Total Fee (37 CFR 3.41)\$ 40.00		
Internal Address:	⊠ Enclosed		
Street Address: <u>12400 Wilshire Boulevard, 7th Floor</u>	Authorized to be charged to deposit account		
City: Los Angeles State: CA ZIP: 90025	8. Deposit Account Number:		
]	02-2666		
	(Attach duplicate copy of this page if paying by deposit account)		
DO NOT USE THIS SPACE			
9. Statement and signature. To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.			
Eric S. Hyman, Reg. No. 30,139	EH 11/1/86		
Name of Person Signing	Signature Date		
Total number of pages including cover sheet, attachments, and document:			
Mail documents to be recorded with required cover sheet information to:			

Assistant Commissioner of Patents, Box Assignments

Washington, D.C. 20231

11/19/1998 JWATKINS 00000189 09191202

Attorney Docket No. 03455.P021 (5/27/97)

PATENT REEL: 9597 FRAME: 0742

ASSIGNMENT

WHEREAS, (1) Wen-Kuan Yeh

(2) Jih-Wen Chou

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

TITLE: METHOD FOR FABRICATING A METAL-OXIDE SEMICONDUCTOR TRANSISTOR

ſ] Filed	Serial No.
- 1	1 1100	Ochai N

[x] Executed concurrently with the execution of this instrument

WHEREAS, United Microelectronics Corp., of No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

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ASSIGNMENT CONTINUED

indicated.	
Signature: Sole or First Joint Inventor: Wen-Kuan Yeh	07-007-98
Signature. Signature	07 - Oct - 98

Second Joint Inventor (if any): Jih-Wen Chou

RECORDED: 11/12/1998

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s)

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PATENT REEL: 9597 FRAME: 0744